

N-CHANNEL MOS FIELD EFFECT TRANSISTOR  
FOR SWITCHING

DESCRIPTION

The  $\mu$ PA1900 is a switching device which can be driven directly by a 2.5 V power source.

The  $\mu$ PA1900 features a low on-state resistance and excellent switching characteristics, and is suitable for applications such as power switch of portable machine and so on.

FEATURES

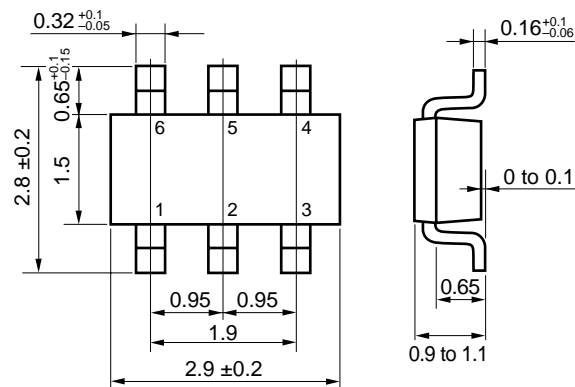
- Can be driven by a 2.5 V power source
- Low on-state resistance

$R_{DS(on)1} = 35 \text{ m}\Omega \text{ MAX. (} V_{GS} = 4.5 \text{ V, } I_D = 3.0 \text{ A)}$

$R_{DS(on)2} = 38 \text{ m}\Omega \text{ MAX. (} V_{GS} = 4.0 \text{ V, } I_D = 3.0 \text{ A)}$

$R_{DS(on)3} = 45 \text{ m}\Omega \text{ MAX. (} V_{GS} = 2.5 \text{ V, } I_D = 3.0 \text{ A)}$

PACKAGE DRAWING (Unit : mm)



1, 2, 5, 6 : Drain  
3 : Gate  
4 : Source

ORDERING INFORMATION

PART NUMBER	PACKAGE
$\mu$ PA1900TE	6-pin Mini Mold (Thin Type)

ABSOLUTE MAXIMUM RATINGS ( $T_A = 25^\circ\text{C}$ )

Drain to Source Voltage	$V_{DSS}$	20	V
Gate to Source Voltage	$V_{GSS}$	$\pm 12$	V
Drain Current (DC)	$I_{D(DC)}$	$\pm 5.5$	A
Drain Current (pulse) <sup>Note1</sup>	$I_{D(pulse)}$	$\pm 22$	A
Total Power Dissipation	$P_{T1}$	0.2	W
Total Power Dissipation <sup>Note2</sup>	$P_{T2}$	2	W
Channel Temperature	$T_{ch}$	150	$^\circ\text{C}$
Storage Temperature	$T_{stg}$	-55 to +150	$^\circ\text{C}$

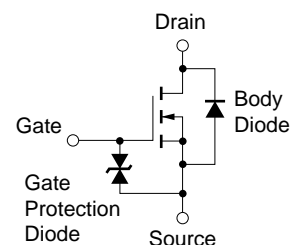
Notes 1.  $PW \leq 10 \mu\text{s}$ , Duty Cycle  $\leq 1 \%$

2. Mounted on FR-4 Board,  $t \leq 5 \text{ sec.}$

**Remark** The diode connected between the gate and source of the transistor serves as a protector against ESD. When this device actually used, an additional protection circuit is externally required if a voltage exceeding the rated voltage may be applied to this device.

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Not all devices/types available in every country. Please check with local NEC representative for availability and additional information.

EQUIVALENT CIRCUIT

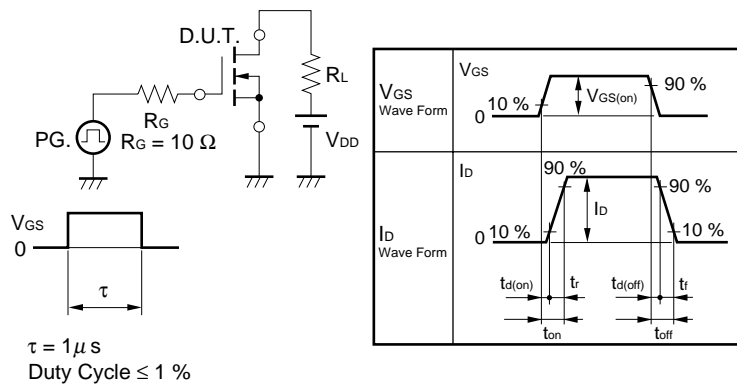


Marking: TG

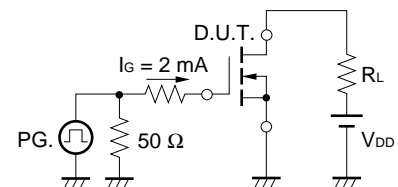
★ ELECTRICAL CHARACTERISTICS (T<sub>A</sub> = 25 °C)

CHARACTERISTICS	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> = 20 V, V <sub>GS</sub> = 0 V			10	μA
Gate Leakage Current	I <sub>GSS</sub>	V <sub>GS</sub> = ±12 V, V <sub>DS</sub> = 0 V			±10	μA
Gate Cut-off Voltage	V <sub>GS(off)</sub>	V <sub>DS</sub> = 10 V, I <sub>D</sub> = 1 mA	0.5	0.93	1.5	V
Forward Transfer Admittance	y <sub>fs</sub>	V <sub>DS</sub> = 10 V, I <sub>D</sub> = 3.0 A	3	9.2		S
Drain to Source On-state Resistance	R <sub>DS(on)1</sub>	V <sub>GS</sub> = 4.5 V, I <sub>D</sub> = 3.0 A		28	35	mΩ
	R <sub>DS(on)2</sub>	V <sub>GS</sub> = 4.0 V, I <sub>D</sub> = 3.0 A		29	38	mΩ
	R <sub>DS(on)3</sub>	V <sub>GS</sub> = 2.5 V, I <sub>D</sub> = 3.0 A		37	45	mΩ
Input Capacitance	C <sub>iss</sub>	V <sub>DS</sub> = 10 V		595		pF
Output Capacitance	C <sub>oss</sub>	V <sub>GS</sub> = 0 V		222		pF
Reverse Transfer Capacitance	C <sub>rss</sub>	f = 1 MHz		133		pF
Turn-on Delay Time	t <sub>d(on)</sub>	V <sub>DD</sub> = 10 V		61		ns
Rise Time	t <sub>r</sub>	I <sub>D</sub> = 3.0 A		172		ns
Turn-off Delay Time	t <sub>d(off)</sub>	V <sub>GS(on)</sub> = 4.0 V		220		ns
Fall Time	t <sub>f</sub>	R <sub>G</sub> = 10 Ω		293		ns
Total Gate Charge	Q <sub>G</sub>	V <sub>DS</sub> = 16 V		6.7		nC
Gate to Source Charge	Q <sub>GS</sub>	I <sub>D</sub> = 5.5 A		1.2		nC
Gate to Drain Charge	Q <sub>GD</sub>	V <sub>GS</sub> = 4.0 V		3.1		nC
Diode Forward Voltage	V <sub>F(S-D)</sub>	I <sub>F</sub> = 5.5 A, V <sub>GS</sub> = 0 V		0.87		V

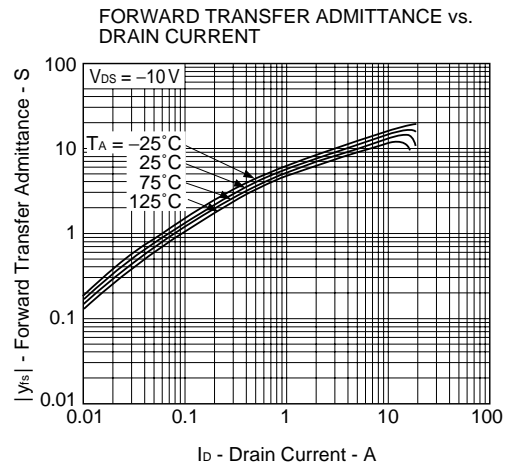
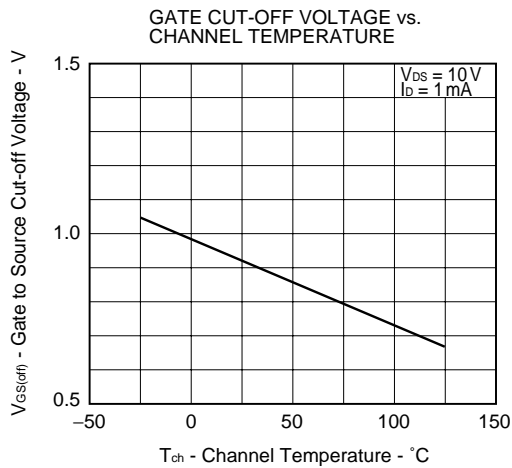
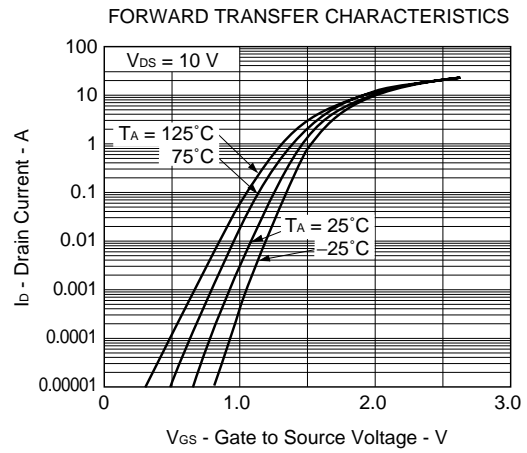
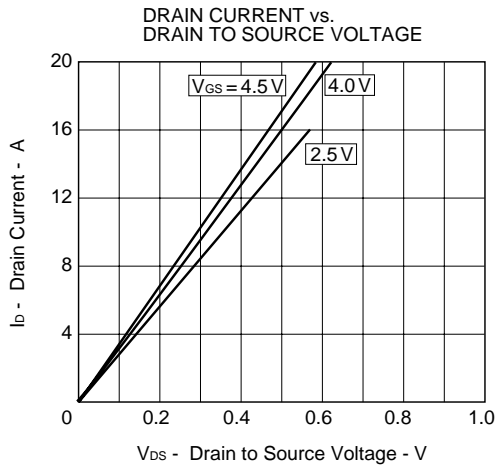
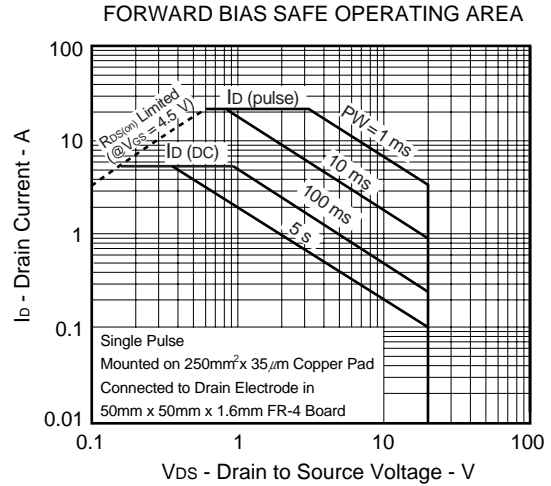
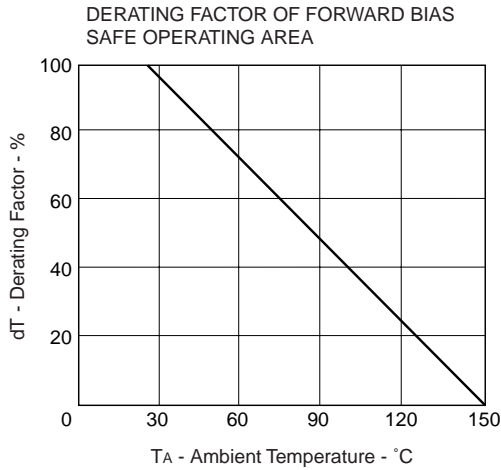
TEST CIRCUIT 1 SWITCHING TIME

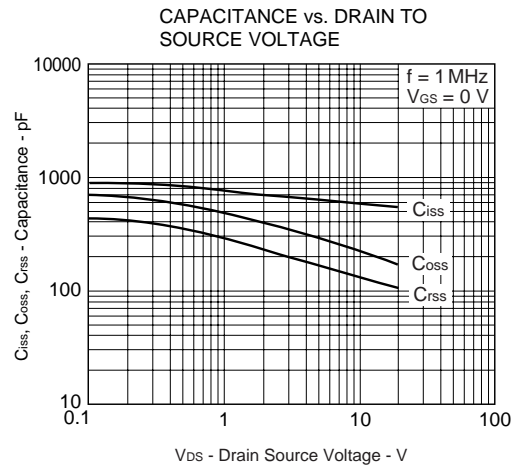
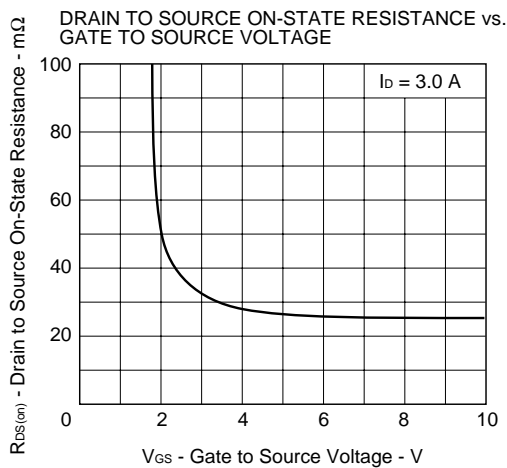
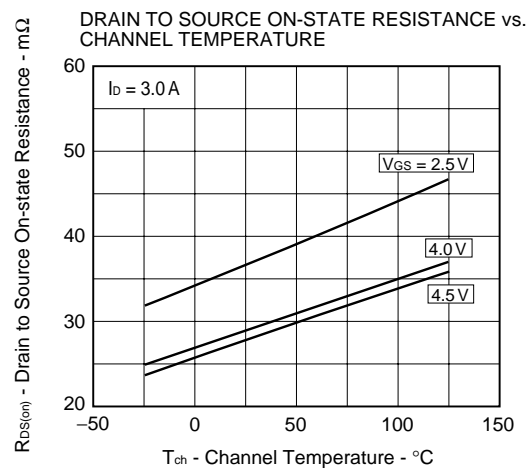
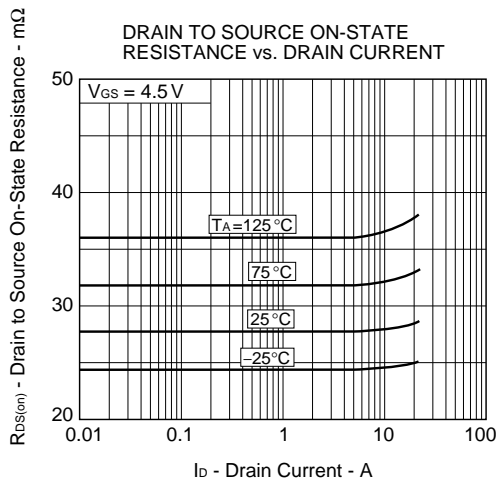
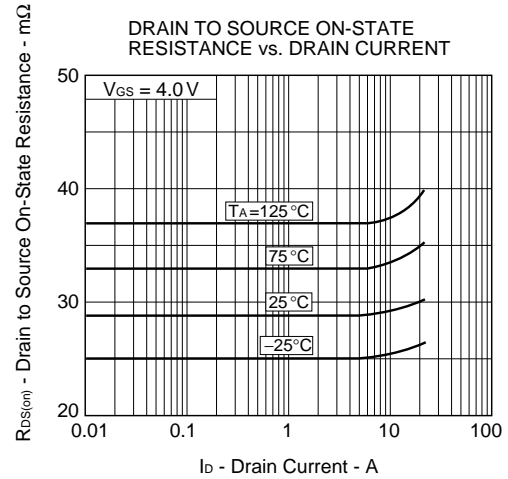
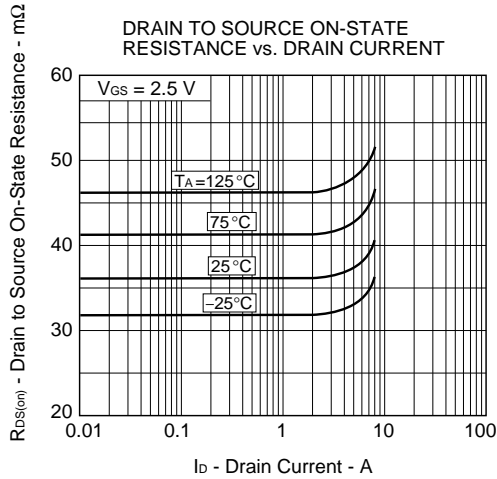


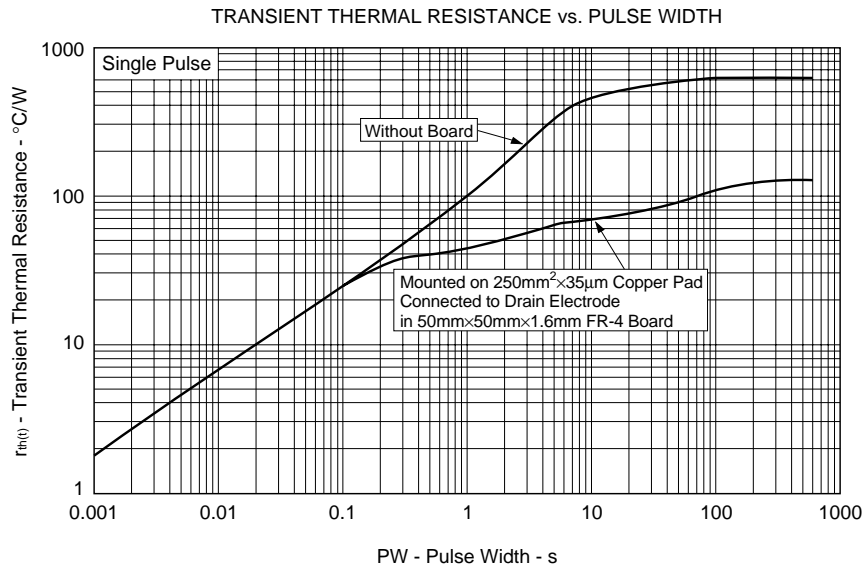
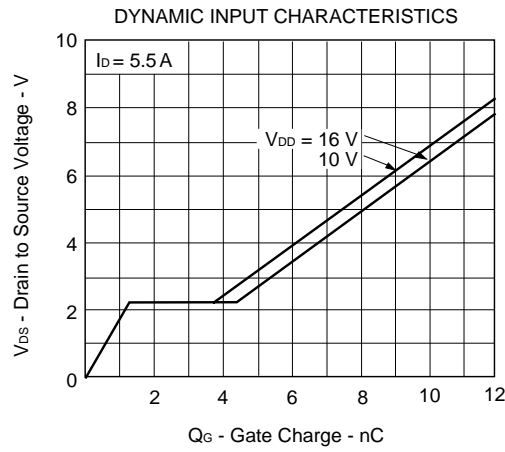
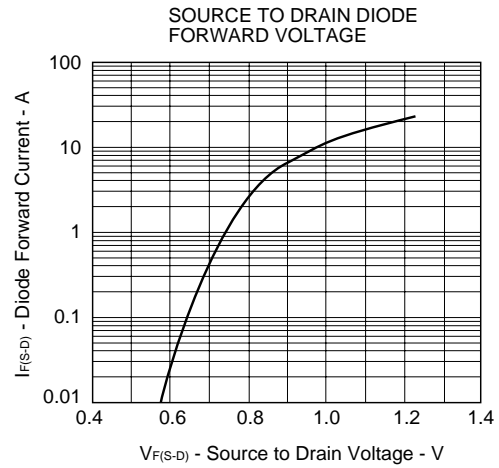
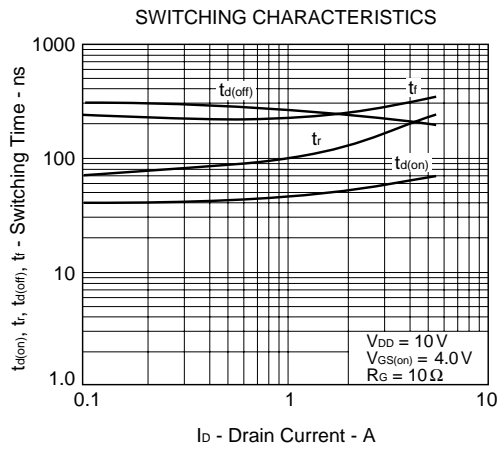
TEST CIRCUIT 2 GATE CHARGE



★ TYPICAL CHARACTERISTICS ( $T_A = 25^\circ\text{C}$ )







[MEMO]

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